GDDR6X Introduction IBIS ATM Task Group

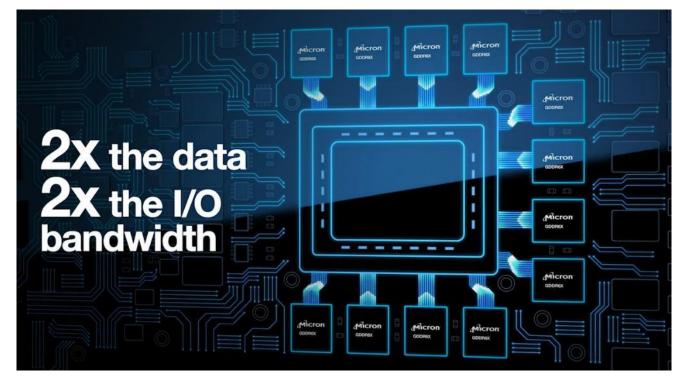
Randy Wolff, Justin Butterfield 10/6/2020

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What's New?

- Micron introduced new Graphics DDR memory GDDR6X
 - https://www.micron.com/products/ultra-bandwidth-solutions/gddr6x
 - Micron Technical Brief
- First use of single-ended PAM4 I/O signaling
- Pushes single-ended I/O speeds beyond 16 Gb/s, targeting up to 32 Gb/s





PAM4 Benefit – Beyond 16 Gb/s

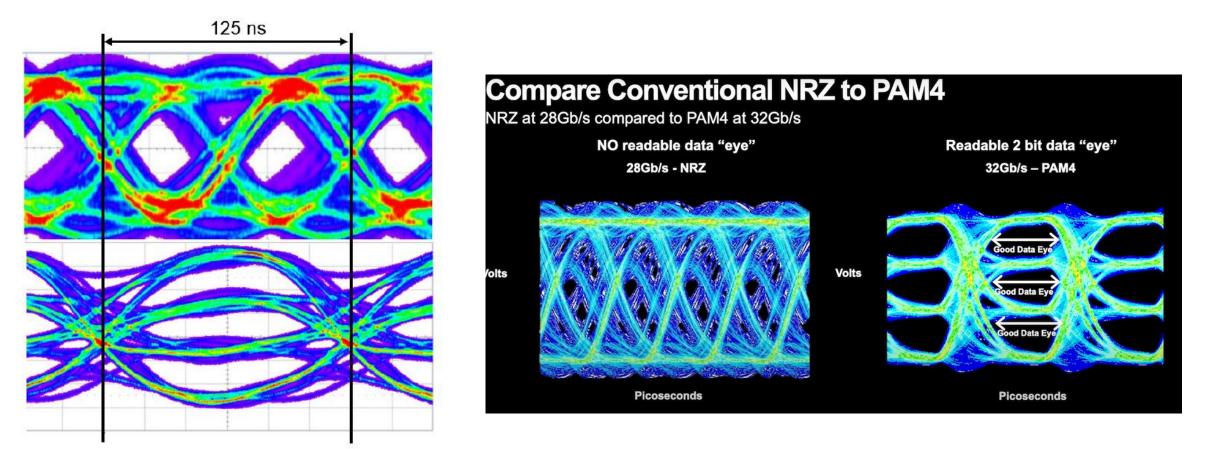


Figure 2: Data Eye Comparison Between GDDR6 (top) and GDDR6X (bottom) That Shows the Timing for a 2 Bits Data Transfer at 16Gb/s



Tx/Rx Specs

- Tx/Rx Equalization
- VDD/VDDQ @ 1.25V or 1.35V
- Datarate (today): 19Gb/s, 21 Gb/s, >21 Gb/s (per pin)
- Data is gray-coded
- V_{REFD} level internal per pin (64 steps), 3 subreceivers per pin
- 40/48 Ohm ODT

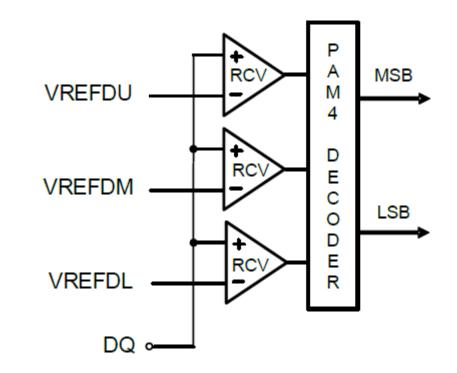


Figure 4: PAM4 Receiver



Tx Impedances

• Tx implemented with 60/120 Ohm PU/PD legs

Logical	Symbol	Physical
10	+3	
11	+1	8
01	-1	8
00	-3	8

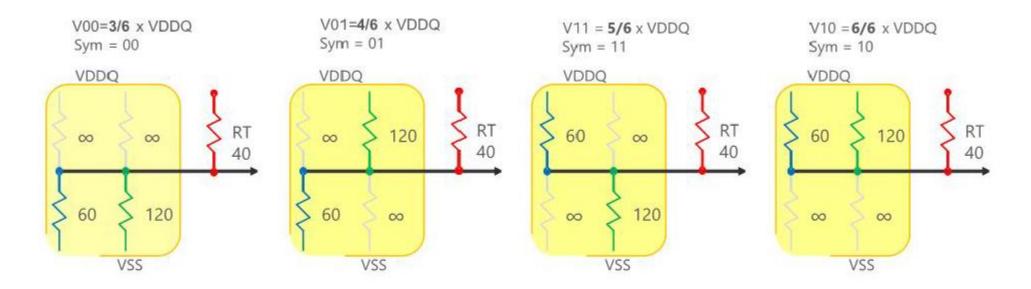
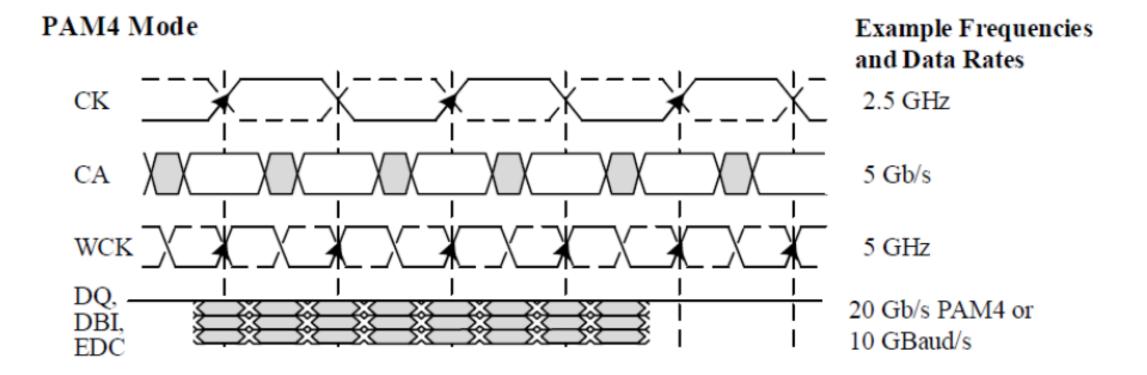


Figure 5: PAM4 Impedance Scheme



Clocking





What is needed from IBIS?

IBIS

- New Model_Types (I/O_PAM4, Input_PAM4, Output_PAM4)
 - MSB/LSB input stimuli
 - Multiple Pullup/Pulldown curves
 - 6 sets of V-t waveforms
 - [Driver Schedule]-like architecture?
- IBIS-AMI
 - EDA tools will need to support new IBIS buffer model for time-domain channel characterization
 - Multiple edge responses (more than single rise/fall edges)
 - Multiple bit responses for superposition techniques
 - $^-$ PAM4_*Threshold levels are V_{REFD} levels. How to set these?
 - Any special handling of DC_Offset?
 - Revamp of IBIS Section 10.7



